

GSID300A120S5C1

6-Pack IGBT Module



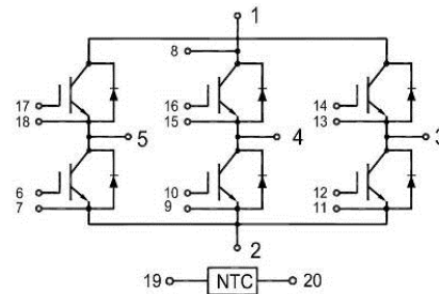
Features:

- Short Circuit Rated 10 μ s
- Low Saturation Voltage: $V_{CE(sat)} = 1.90V @ I_C = 300A, T_C=25^\circ C$
- Low Switching Loss
- 100% RBSOA Tested ($2 \times I_C$)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



Applications:

- High Power Converters
- Motor Drivers
- UPS Systems



IGBT, Inverter

Maximum Rated Values ($T_C=25^\circ C$ unless otherwise specified)

V_{CES}	Collector-Emitter Blocking Voltage		1200	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Continuous Collector Current	$T_C = 80^\circ C$	300	A
		$T_C = 25^\circ C$	430	A
$I_{CM(1)}$	Peak Collector Current Repetitive	$T_J = 175^\circ C$	600	A
t_{SC}	Short Circuit Withstand Time		>10	μs
P_D	Maximum Power Dissipation per IGBT	$T_C = 25^\circ C$ $T_{Jmax} = 175^\circ C$	1630	W

Electrical Characteristics of IGBT ($T_C=25^\circ\text{C}$ unless otherwise specified)

Static characteristics

Symbol	Description	Conditions	Min	Typ	Max	Unit
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C = 10\text{ mA}, V_{CE} = V_{GE}$	5.0	5.5	6.8	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 300\text{A}, V_{GE} = 15\text{V}$	$T_J = 25^\circ\text{C}$	1.9	2.25	V
			$T_J = 125^\circ\text{C}$	2.30		V
			$T_J = 150^\circ\text{C}$	2.30		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE} = 0\text{V}, V_{CE} = V_{CES}, T_J = 25^\circ\text{C}$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE} = \pm 20\text{V}, V_{CE} = 0\text{V}, T_J = 25^\circ\text{C}$			400	nA
R_{G_INT}	Internal Gate Resistance			1.0		Ω
C_{ies}	Input Capacitance	$V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$		30.0		nF
C_{oes}	Output Capacitance			0.86		nF
C_{res}	Reverse Transfer Capacitance			0.70		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC} = 600\text{V}, I_C = 300\text{A}, R_G = 2\Omega, V_{GE} = \pm 15\text{V}, \text{Inductive Load}$	$T_J = 25^\circ\text{C}$	465		ns
			$T_J = 125^\circ\text{C}$	479		
			$T_J = 150^\circ\text{C}$	483		
t_r	Rise Time		$T_J = 25^\circ\text{C}$	143		ns
			$T_J = 125^\circ\text{C}$	149		
			$T_J = 150^\circ\text{C}$	152		
$t_{d(off)}$	Turn-off Delay Time		$T_J = 25^\circ\text{C}$	582		ns
			$T_J = 125^\circ\text{C}$	609		
			$T_J = 150^\circ\text{C}$	614		
t_f	Fall Time	$T_J = 25^\circ\text{C}$	243		ns	
		$T_J = 125^\circ\text{C}$	329			
		$T_J = 150^\circ\text{C}$	338			
E_{on}	Turn-on Switching Loss	$T_J = 25^\circ\text{C}$	6.15		mJ	
		$T_J = 125^\circ\text{C}$	9.00			

			$T_J = 150^\circ\text{C}$		9.75		
E_{off}	Turn-off Switching Loss	$V_{\text{CC}} = 600\text{V}, I_{\text{C}} = 300\text{A},$ $R_{\text{G}} = 2\Omega, V_{\text{GE}} = \pm 15\text{V},$ Inductive Load	$T_J = 25^\circ\text{C}$		17.55		mJ
			$T_J = 125^\circ\text{C}$		24.15		
			$T_J = 150^\circ\text{C}$		27.15		
Q_{g}	Total Gate Charge		$T_J = 25^\circ\text{C}$		2876		nC
			$T_J = 125^\circ\text{C}$		2911		
			$T_J = 150^\circ\text{C}$		2921		
RBSOA	Reverse Bias Safe Operation Area	$I_{\text{C}}=600\text{A}, V_{\text{CC}}=1050\text{V}, V_{\text{p}}=1200\text{V},$ $R_{\text{g}} = 5\Omega, V_{\text{GE}}=+15\text{V to } 0\text{V}, T_J = 150^\circ\text{C}$	Trapezoid				
SCSOA	Short Circuit Safe Operation Area	$V_{\text{CC}} < 720\text{V}, V_{\text{GE}} = 15\text{V},$ $T_J = 150^\circ\text{C}$	10				μs
$R_{\theta\text{JC}}$	IGBT Thermal Resistance: Junction-To-Case				0.092		$^\circ\text{C/W}$

Diode, Inverter

Maximum Rated Values ($T_{\text{C}}=25^\circ\text{C}$ unless otherwise specified)

V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_{F}	Diode Continuous Forward Current	300	A
I_{FM}	Repetitive Peak Forward Current	600	A

Electrical Characteristics of FWD ($T_{\text{C}}=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min	Typ	Max	Unit
V_{FM}	Forward Voltage	$I_{\text{F}} = 300\text{A},$ $V_{\text{GE}} = 0\text{V}$	$T_J = 25^\circ\text{C}$		1.70	V
			$T_J = 125^\circ\text{C}$		1.80	
			$T_J = 150^\circ\text{C}$		1.75	
I_{rr}	Peak Reverse Recovery Current	$I_{\text{F}}=300\text{A},$ $di/dt = 1028\text{A}/\mu\text{s},$ $V_{\text{rr}} = 600\text{V},$ $V_{\text{GE}} = -15\text{V}$	$T_J = 25^\circ\text{C}$		147.6	A
			$T_J = 125^\circ\text{C}$		193.7	
			$T_J = 150^\circ\text{C}$		210.0	
Q_{rr}	Reverse Recovery Charge		$T_J = 25^\circ\text{C}$		13.14	μC
			$T_J = 125^\circ\text{C}$		25.47	

			$T_J = 150^\circ\text{C}$		30.45		
E_{rec}	Reverse Recovery Energy		$T_J = 25^\circ\text{C}$		7.23		mJ
			$T_J = 125^\circ\text{C}$		13.04		
			$T_J = 150^\circ\text{C}$		15.79		
$R_{\theta\text{JC}}$	Diode Thermal Resistance: Junction-To-Case				0.118		$^\circ\text{C}/\text{W}$

Internal NTC-Thermistor Characteristics

Symbol	Description	Min	Typ	Max	Unit
R_{25}	$T_C = 25^\circ\text{C}$		5		k Ω
$\Delta R/R$	$T_C = 100^\circ\text{C}$, $R_{100} = 481\Omega$			± 5	%
P_{25}	$T_C = 25^\circ\text{C}$		50		mW
$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298.15\text{K}))]$		3380		K
$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298.15\text{K}))]$		3440		K

Module

Symbol	Description	Min	Typ	Max	Unit
V_{iso}	Isolation Voltage(All Terminals Shorted) $f = 50\text{Hz}$, 1minute			2500	V
T_J	Maximum Junction Temperature			175	$^\circ\text{C}$
T_{JOP}	Maximum Operating Junction Temperature Range	-40		+150	$^\circ\text{C}$
T_{stg}	Storage Temperature	-40		+125	$^\circ\text{C}$
$R_{\theta\text{CS}}$	Case-To-Sink (Conductive Grease Applied)		0.02		$^\circ\text{C}/\text{W}$
M	Mounting Screw:M5	3.0		6.0	N·m
M	Power Terminals Screw: M6	3.0		6.0	N·m
G	Weight		390		g

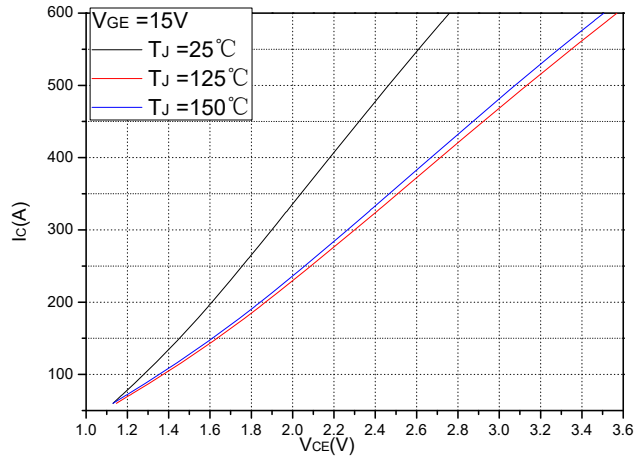


Fig.1 Typical Saturation Voltage Characteristics

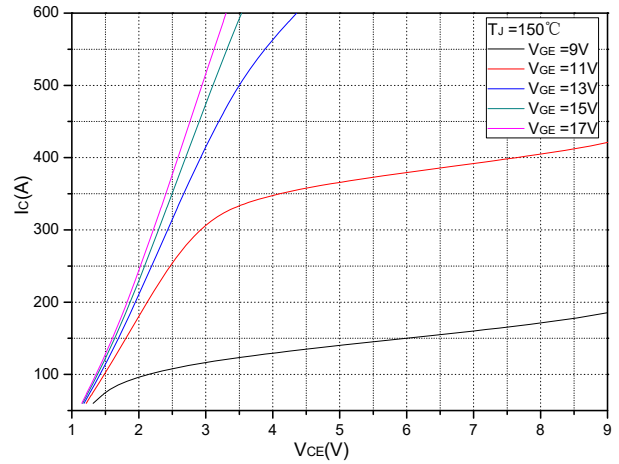


Fig.2 Typical Output Characteristics

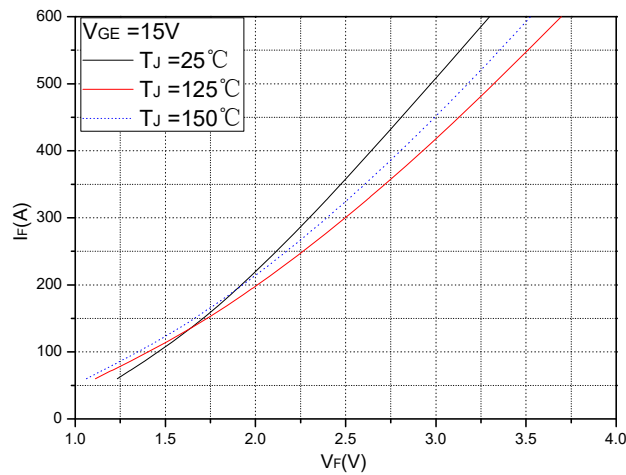


Fig.3 Forward Characteristics of FWD

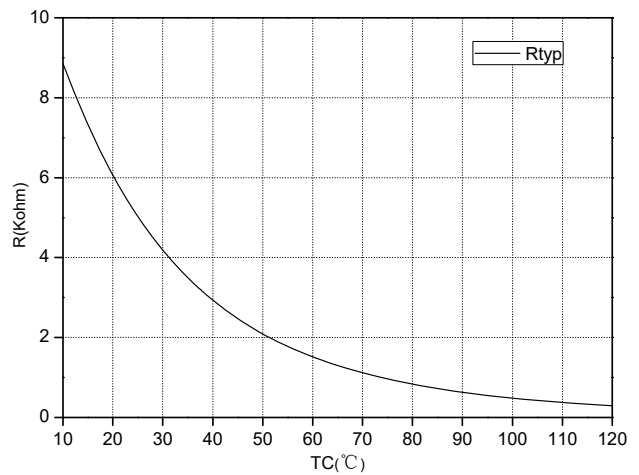


Fig.4 NTC Temperature characteristics

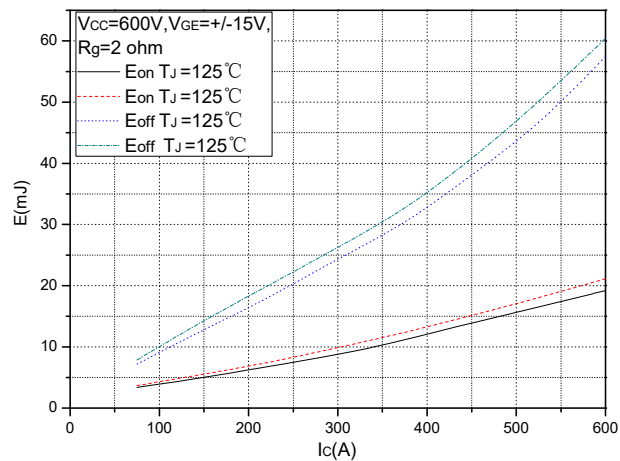


Fig.5 Typical Switching Loss vs. Collector Current

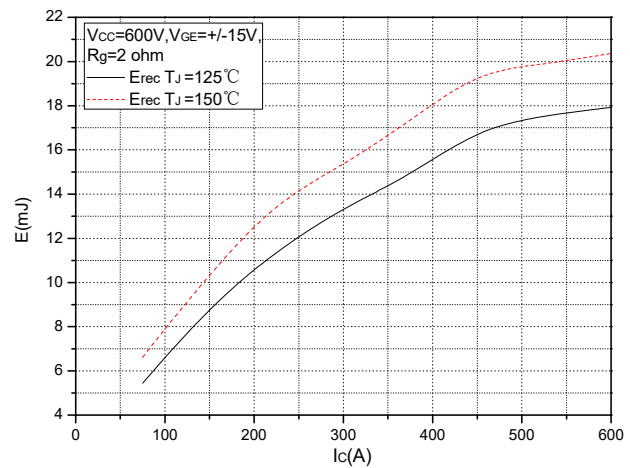


Fig.6 Typical Switching Loss vs. Collector Current

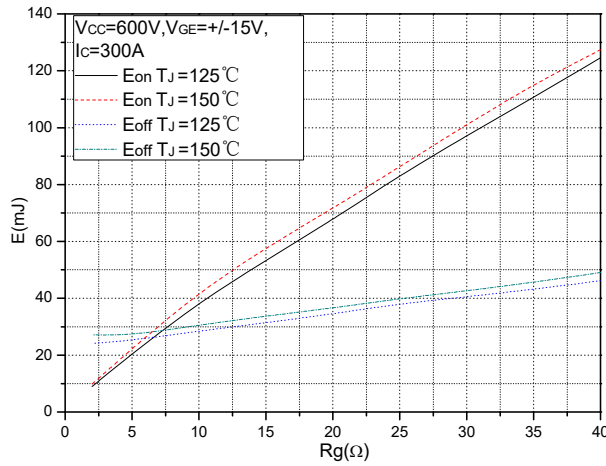


Fig.7 Typical Switching Loss vs. Gate Resistance

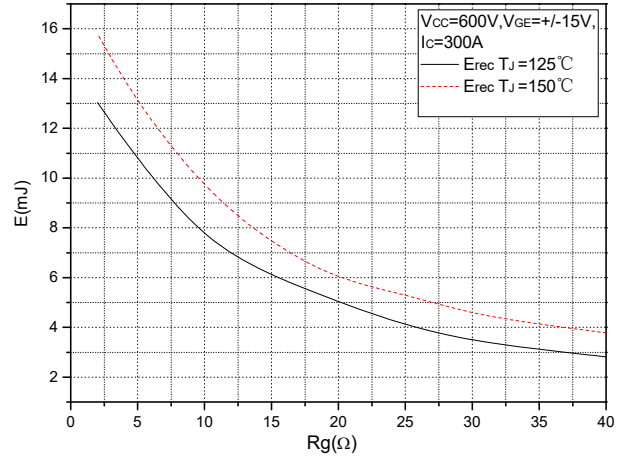


Fig.8 Typical Switching Loss vs. Gate Resistance

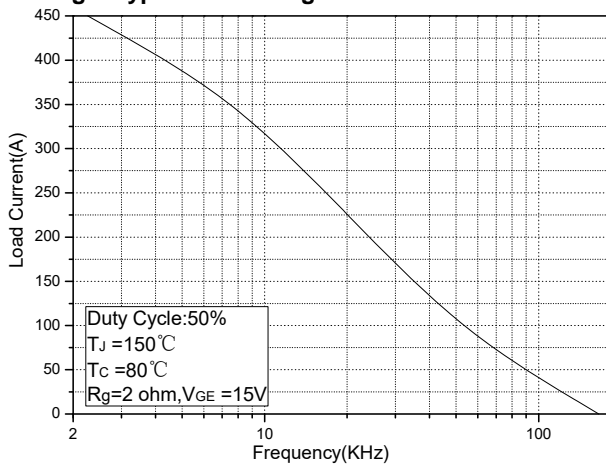


Fig.9 Typical Load Current vs. Frequency

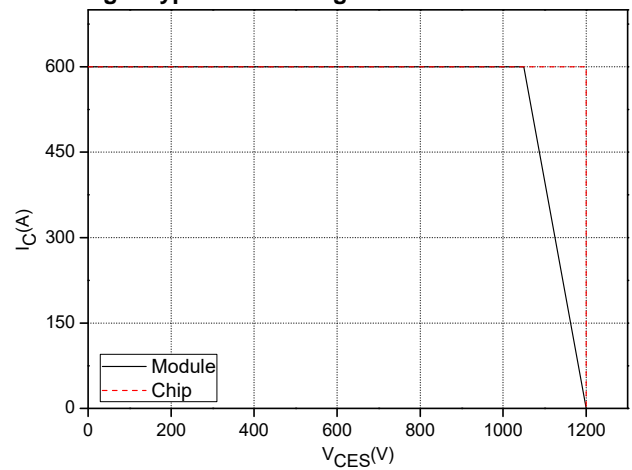


Fig.10 Reverse Bias Safe Operation Area (RBSOA)

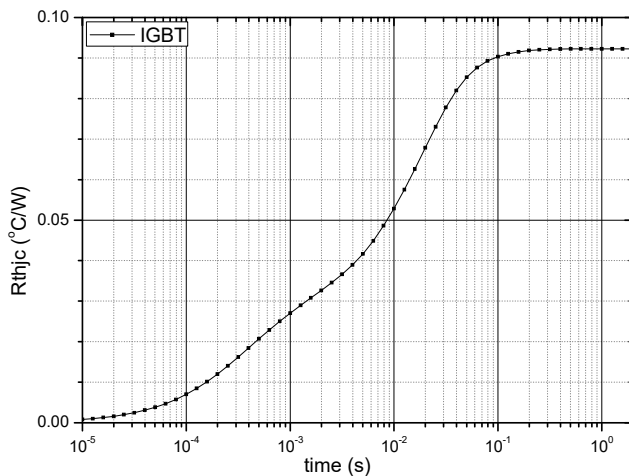


Fig.11 Transient thermal impedance (IGBT)

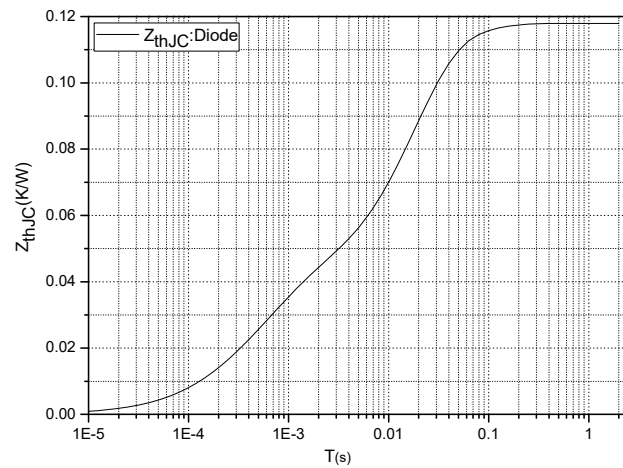
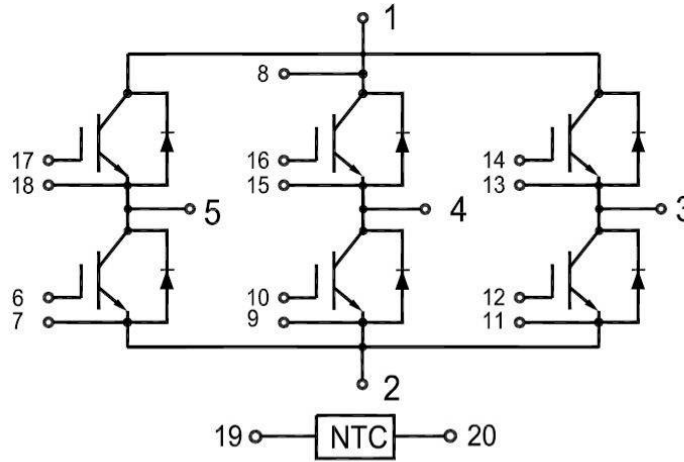
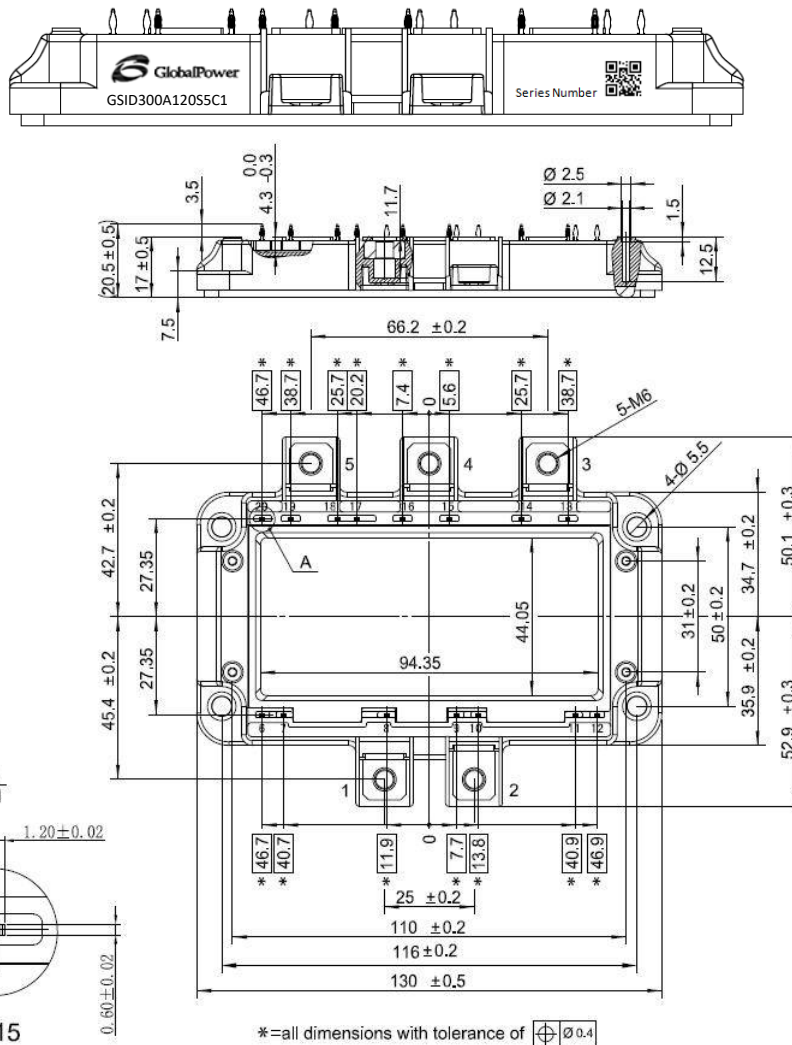


Fig.12 Transient thermal impedance (Diode)

Internal Circuit



Package Outline (Unit: mm):



Revision History

Date	Revision	Notes
10/15/2015	0.1	Initial release of preliminary datasheet.
11/02/2015	0.2	Modified the test data at junction temperature of 150°C.
12/16/2015	0.3	Modified Freewheeling diode and dynamic performances data
01/31/2016	0.4	Add the internal gate resistor parameter
01/03/2020	0.5	Applied company name change

Notes

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

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